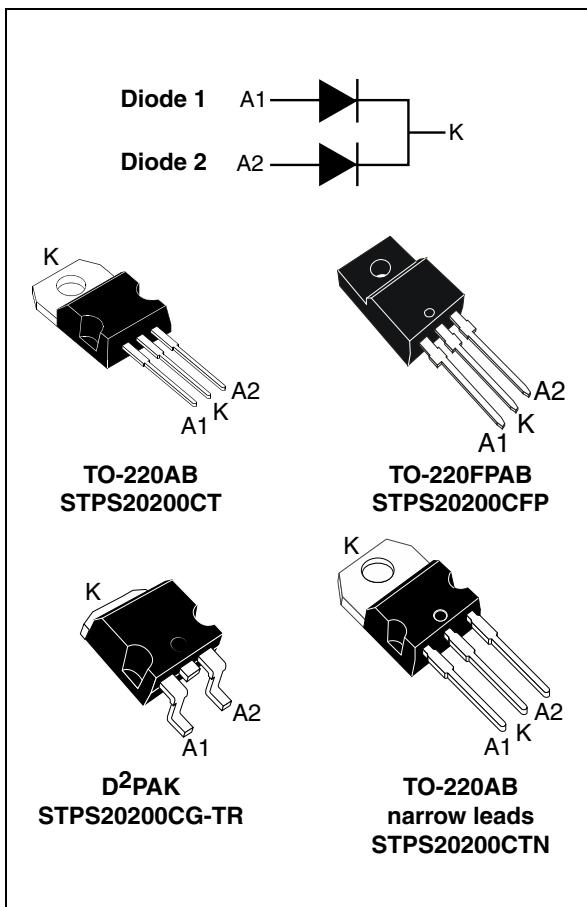


## Power Schottky diode

Datasheet – production data



## Features

- Low forward voltage drop
- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low thermal resistance
- -40°C minimum operating  $T_j$
- Insulated package: TO-220FPAB
  - Insulating voltage: 2000 V DC
  - Capacitance: 45 pF
- ECOPACK®2 compliant component

## Description

This device is a dual center tap 200 V Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in TO-220AB, TO-220AB narrow-leads, TO-220FPAB and D<sup>2</sup>PAK, it is especially intended for use as secondary rectification in SMPS and is also ideal for all LED lighting applications.

**Table 1. Device summary**

Symbol	Value
$I_{F(AV)}$	2 x 10 A
$V_{RRM}$	200 V
$T_j(\text{max})$	175 °C
$V_F(\text{typ})$	0.64 V

# 1 Characteristics

**Table 2. Absolute ratings (limiting values, per diode, unless otherwise stated)**

Symbol	Parameter				Value	Unit			
V <sub>RRM</sub>	Repetitive peak reverse voltage				200	V			
I <sub>F(RMS)</sub>	Forward rms current				30	A			
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$ , square wave	TO-220AB, D <sup>2</sup> PAK, TO 220AB narrow leads	T <sub>c</sub> = 160 °C	Per device	20	A			
		TO-220FPAB	T <sub>c</sub> = 105 °C	Per device	20	A			
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal, T <sub>amb</sub> = 25 °C			180	A			
T <sub>stg</sub>	Storage temperature range				-65 to +175	°C			
T <sub>j</sub>	Operating junction temperature range <sup>(1)</sup>				-40 to +175	°C			

1.  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  condition to avoid thermal runaway for a diode on its own heatsink

**Table 3. Thermal parameters**

Symbol	Parameter				Value	Unit
R <sub>th(j-c)</sub>	Junction to case	D <sup>2</sup> PAK, TO-220AB, TO-220AB narrow leads	Per diode	1.30	°C/W	
			Per device	0.75		
	TO-220FPAB		Per diode	5.00		
			Per device	4.15		
R <sub>th(c)</sub>	Coupling	D <sup>2</sup> PAK, TO-220AB, TO-220AB narrow leads	0.20	°C/W		
		TO-220FPAB	3.30			

General formula to calculate T<sub>j</sub>(diode1) and T<sub>j</sub>(diode2):

$$T_j(\text{diode1}) = P(\text{diode1}) \times R_{th(j-c)}(\text{per diode}) + P(\text{diode2}) \times R_{th(c)} + T_{case}$$

$$T_j(\text{diode2}) = P(\text{diode2}) \times R_{th(j-c)}(\text{per diode}) + P(\text{diode1}) \times R_{th(c)} + T_{case}$$

**Table 4. Static electrical characteristics (per diode)**

Symbol	Test conditions			Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$			15	$\mu\text{A}$
		$T_j = 125^\circ\text{C}$			1.3	7	$\text{mA}$
		$T_j = 125^\circ\text{C}$	$V_R = 150\text{ V}$			4.5	
$V_F^{(1)}$	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 10\text{ A}$			0.86	$\text{V}$
		$T_j = 125^\circ\text{C}$			0.64	0.70	$\text{V}$

1. Pulse test:  $t_p = 380\ \mu\text{s}$ ,  $\delta < 2\%$

To evaluate the maximum conduction losses use the following equation:

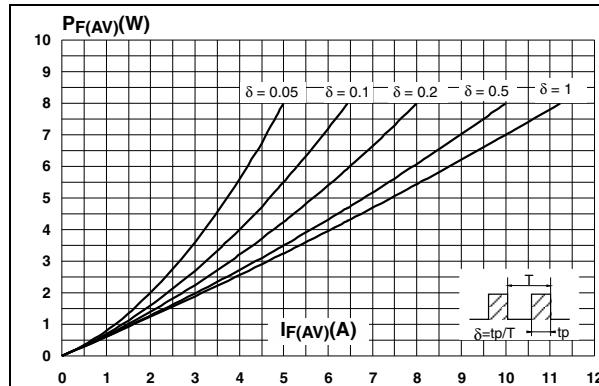
$$P = 0.6 \times I_{F(\text{AV})} + 0.01 I_F^2 (\text{RMS})$$

Note: *More information is available in the application notes:*

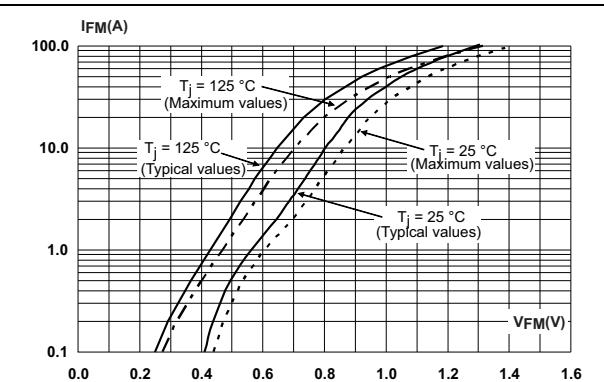
*AN604 Calculation of conduction losses in a power rectifier*

*AN4021 Calculation of reverse losses in a power diode*

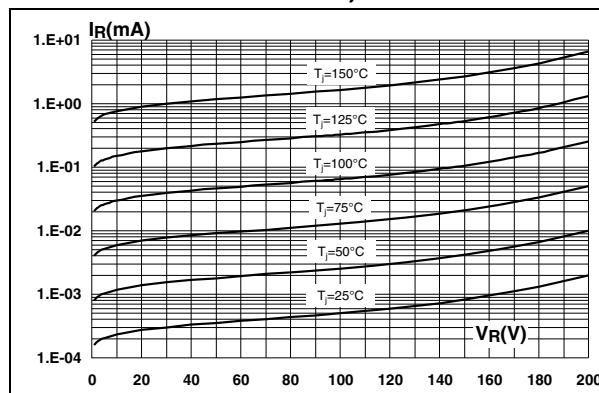
**Figure 1. Average forward power dissipation versus average forward current (per diode)**



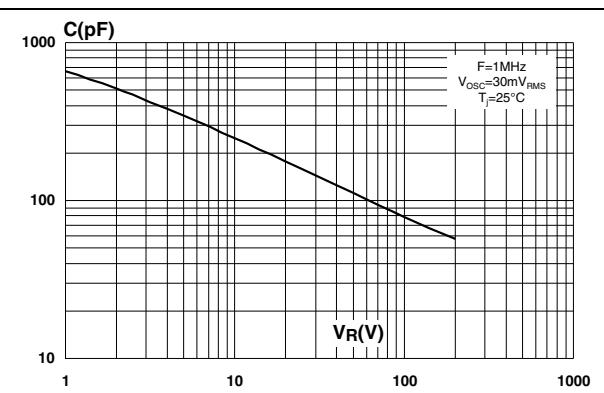
**Figure 2. Forward voltage drop versus forward current (per diode)**



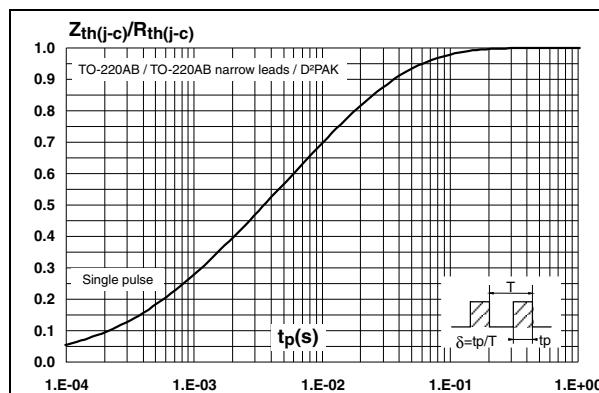
**Figure 3. Reverse leakage current versus reverse voltage applied (typical values, per diode)**



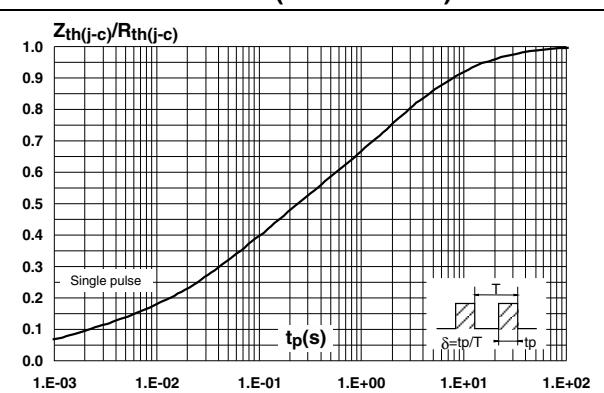
**Figure 4. Junction capacitance versus reverse voltage applied (typical values, per diode)**

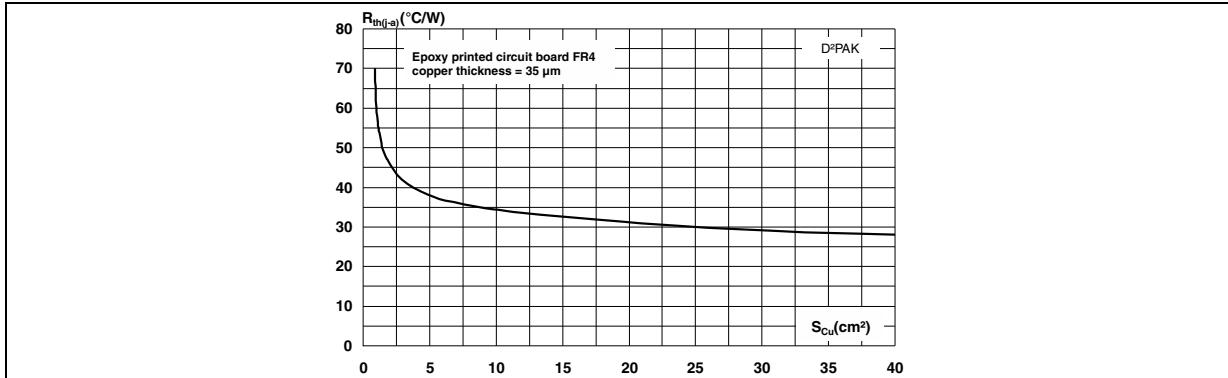


**Figure 5. Relative variation of thermal impedance junction to case versus pulse duration**



**Figure 6. Relative variation of thermal impedance junction to case versus pulse duration (TO-220FPAB)**



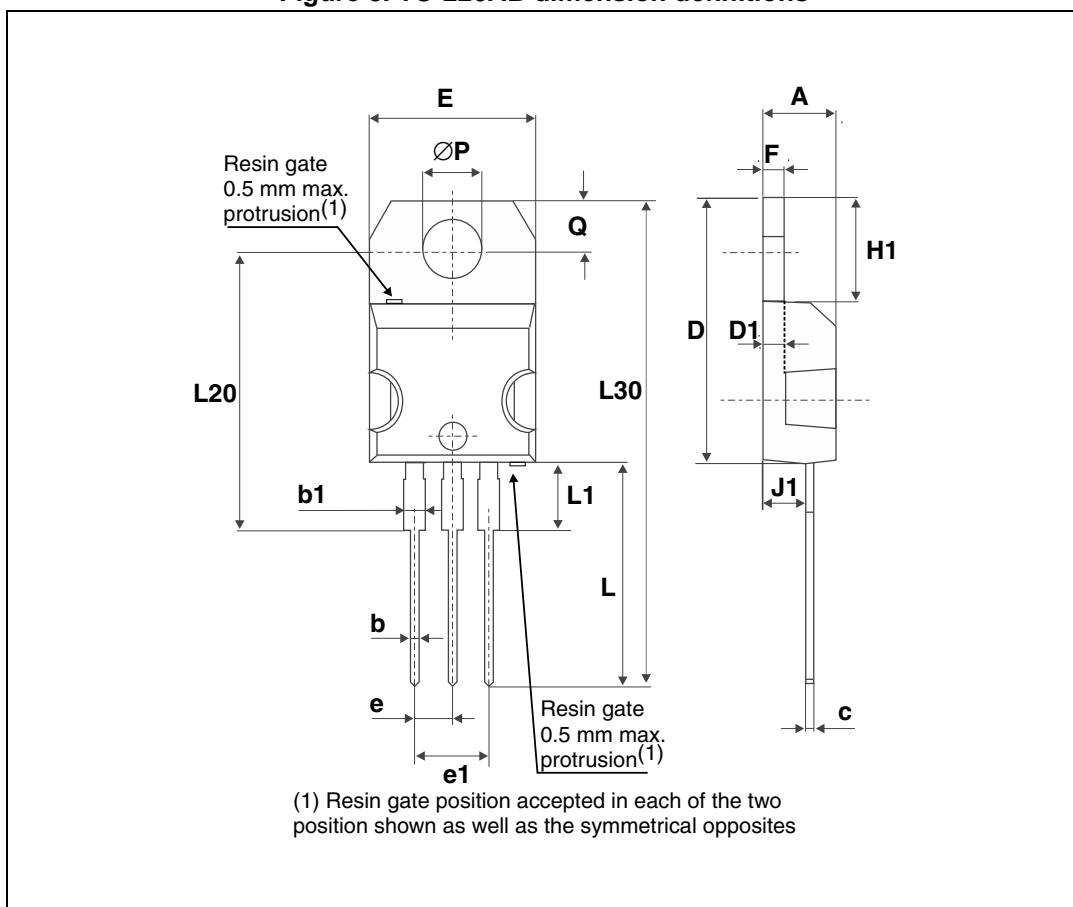
**Figure 7. Thermal resistance junction to ambient versus copper surface under tab**

## 2 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

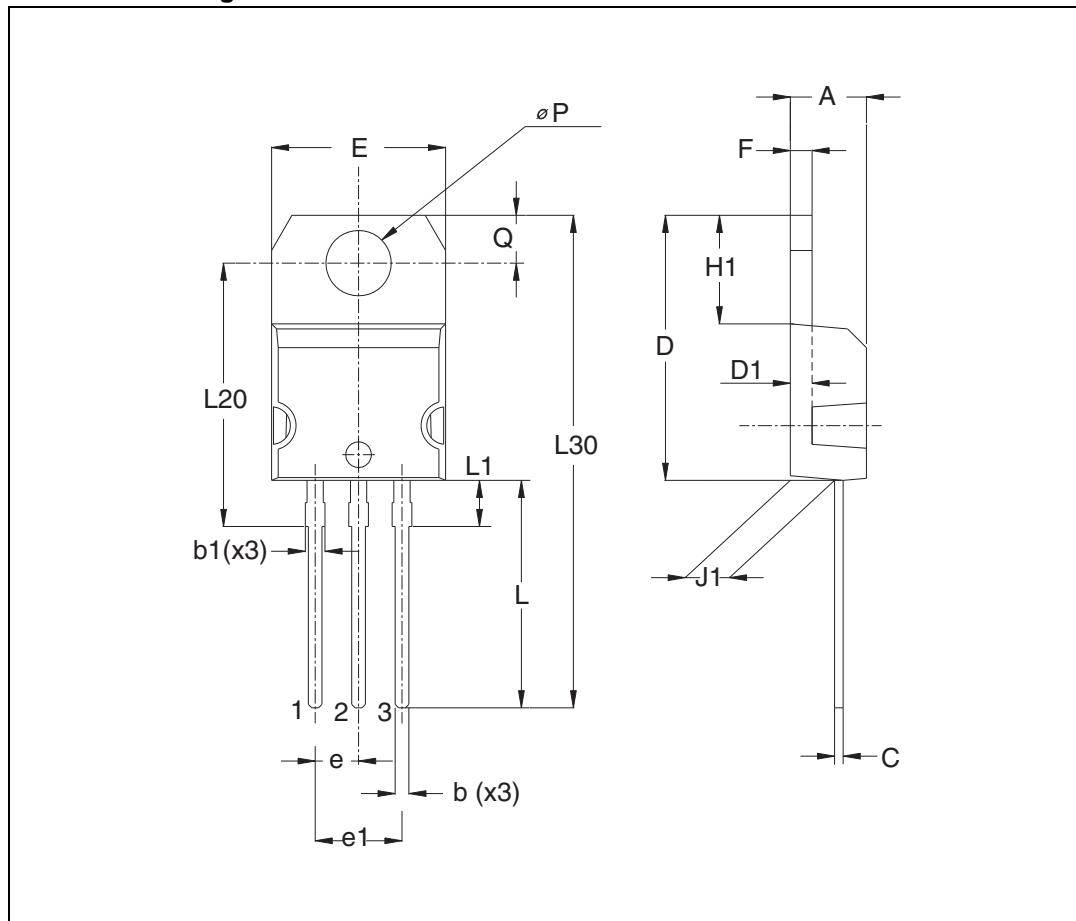
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

Figure 8. TO-220AB dimension definitions



**Table 5. TO-220AB dimension values**

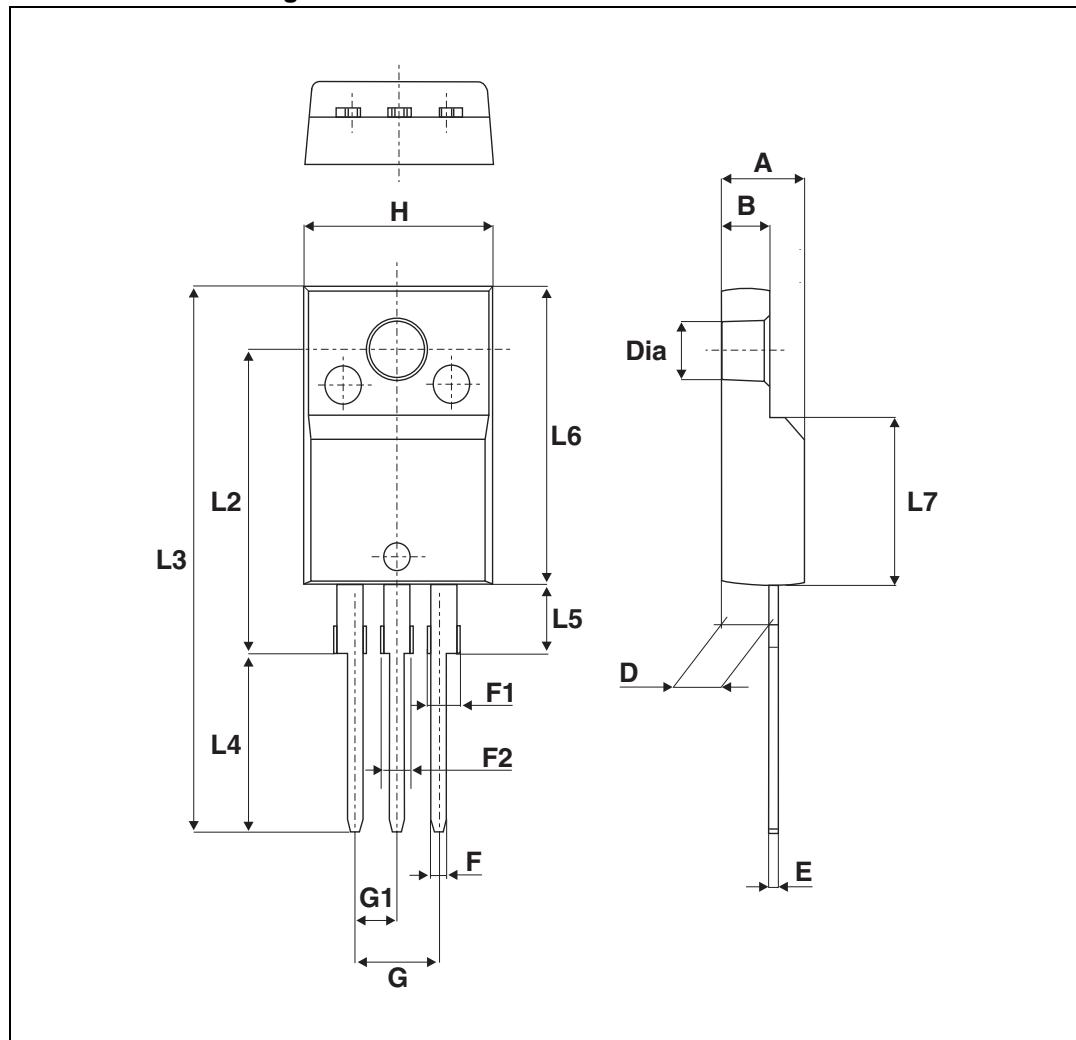
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.17		0.18
b	0.61		0.88	0.024		0.035
b1	1.14		1.70	0.045		0.067
c	0.48		0.70	0.019		0.027
D	15.25		15.75	0.60		0.62
D1		1.27			0.05	
E	10		10.40	0.39		0.41
e	2.40	0.40	2.70	0.094		0.106
e1	4.95	0.60	5.15	0.19		0.20
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.24		0.26
J1	2.40		2.72	0.094		0.107
L	13		14	0.51		0.55
L1	3.50		3.93	0.137		0.154
L20		16.40			0.64	
L30		28.90			1.13	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95		0.104	

**Figure 9. TO-220AB narrow leads dimension definitions**

**Table 6. TO-220AB narrow leads dimension values**

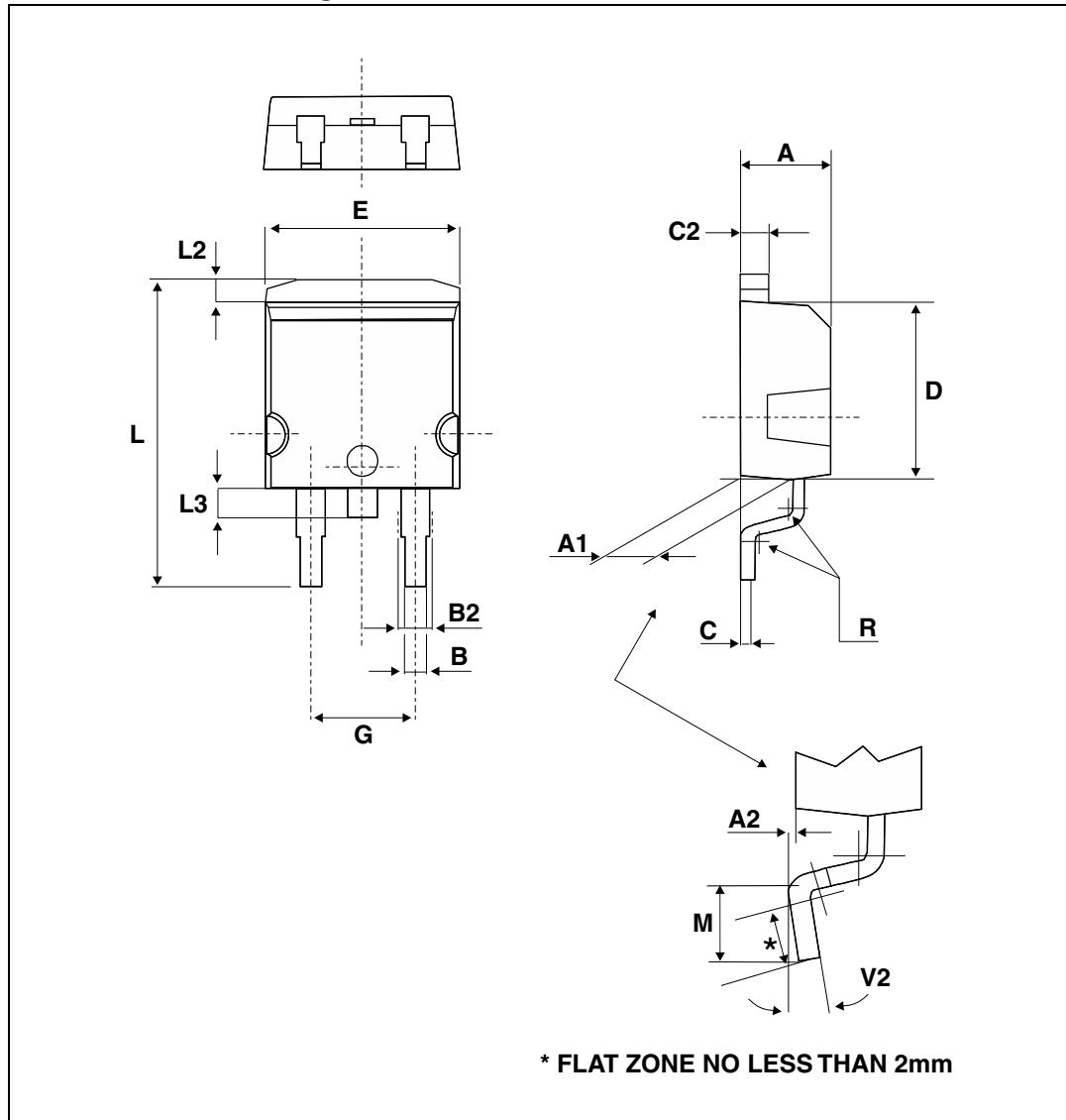
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.17		0.18
b	0.61		0.88	0.024		0.034
b1	0.95		1.20	0.037		0.047
c	0.48		0.70	0.019		0.027
D	15.25		15.75	0.60		0.62
D1		1.27			0.05	
E	10.00		10.40	0.39		0.41
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.19		0.20
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.24		0.26
J1	2.40		2.72	0.095		0.107
L	13.00		14.00	0.51		0.55
L1	2.60		2.90	0.102		0.114
L20		15.40			0.61	
L30		28.90			1.14	
ØP	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116

Figure 10. TO-220FPAB dimension definitions



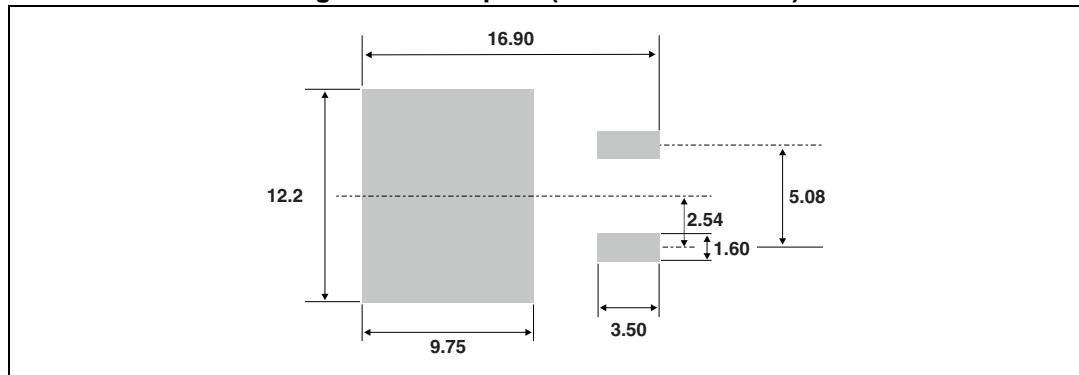
**Table 7. TO-220FPAB dimension values**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.4		4.6	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.70	0.018		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.70	0.045		0.067
F2	1.15		1.70	0.045		0.067
G	4.95		5.20	0.195		0.205
G1	2.4		2.7	0.094		0.106
H	10		10.4	0.393		0.409
L2		16		.	0.63	
L3	28.6		30.6	1.126		1.205
L4	9.8		10.6	0.386		0.417
L5	2.9		3.6	0.114		0.142
L6	15.9		16.4	0.626		0.646
L7	9.00		9.30	0.354		0.366
Dia.	3.00		3.20	0.118		0.126

**Figure 11. D<sup>2</sup>PAK dimension definitions**

**Table 8. D<sup>2</sup>PAK dimension values**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.7		0.93	0.027		0.037
B2	1.14		1.70	0.045		0.067
C	0.45		0.60	0.017		0.024
C2	1.23		1.36	0.048		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.40	0.393		0.409
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.30		1.75	0.051		0.069
M	2.29		2.79	0.090		0.110
R		0.40			0.016	
V2	0°		8°	0°		8°

**Figure 12. Footprint (dimensions in mm)**

### 3 Ordering information

**Table 9. Ordering information**

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS20200CT	STPS20200CT	TO-220AB	2.20 g	50	Tube
STPS20200CTN	STPS20200CTN	TO-220AB narrow leads	1.90 g	50	Tube
STPS20200CFP	STPS20200CFP	TO-220FPAB	2.0 g	50	Tube
STPS20200CG-TR	STPS20200CG	D <sup>2</sup> PAK	1.48g	1000	Tape and reel

### 4 Revision history

**Table 10. Document revision history**

Date	Revision	Changes
11-Apr-2013	1	First issue
16-Oct-2013	2	Updated <a href="#">Table 4</a> .

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